

09/759,018**Patent**
IBM Docket No. FIS920000310US1

5. (Currently amended) The electronic device according to claim 4, wherein said composition is ~~contained within~~ a scratch coat covering an active surface of said integrated circuit.
6. (Original) The electronic device according to claim 4, further comprising:
- a package, to which said integrated circuit is bonded.
7. (Currently amended) The electronic device according to claim 6, wherein said composition is ~~contained within~~ an encapsulant which is deposited over substantially an entire surface of said integrated circuit and between said integrated circuit and said package.
8. (Currently amended) The electronic device according to claim 6, wherein said composition is ~~contained within~~ an underfill which is deposited between said integrated circuit and said package.
9. (Currently amended) The electronic device according to claim 6, wherein said package comprises an organic package and wherein said composition is ~~contained within~~ said organic package.
10. (Original) The electronic device according to claim 6, further comprising:
- a printed circuit board to which said package is bonded.

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11. (Currently amended) The electronic device according to claim 10, wherein said composition is ~~contained within~~ an underfill which is deposited between said package and said printed circuit board.

12. (Currently amended) The electronic device according to claim 10, wherein said composition is ~~contained within~~ said printed circuit board.

13. (Currently amended) The electronic device according to claim 10, wherein said composition is ~~contained within~~ a conformal coating which is deposited over said integrated circuit, said package and said printed board.

Claims 14-37 Withdrawn.